



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

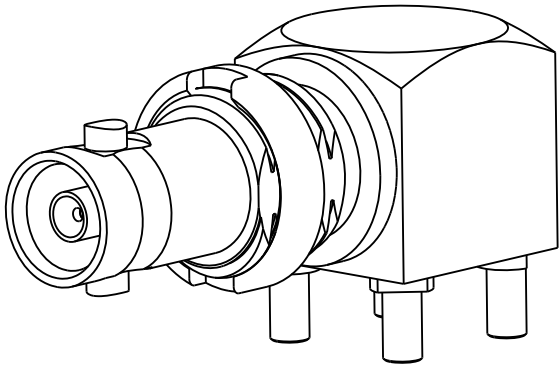
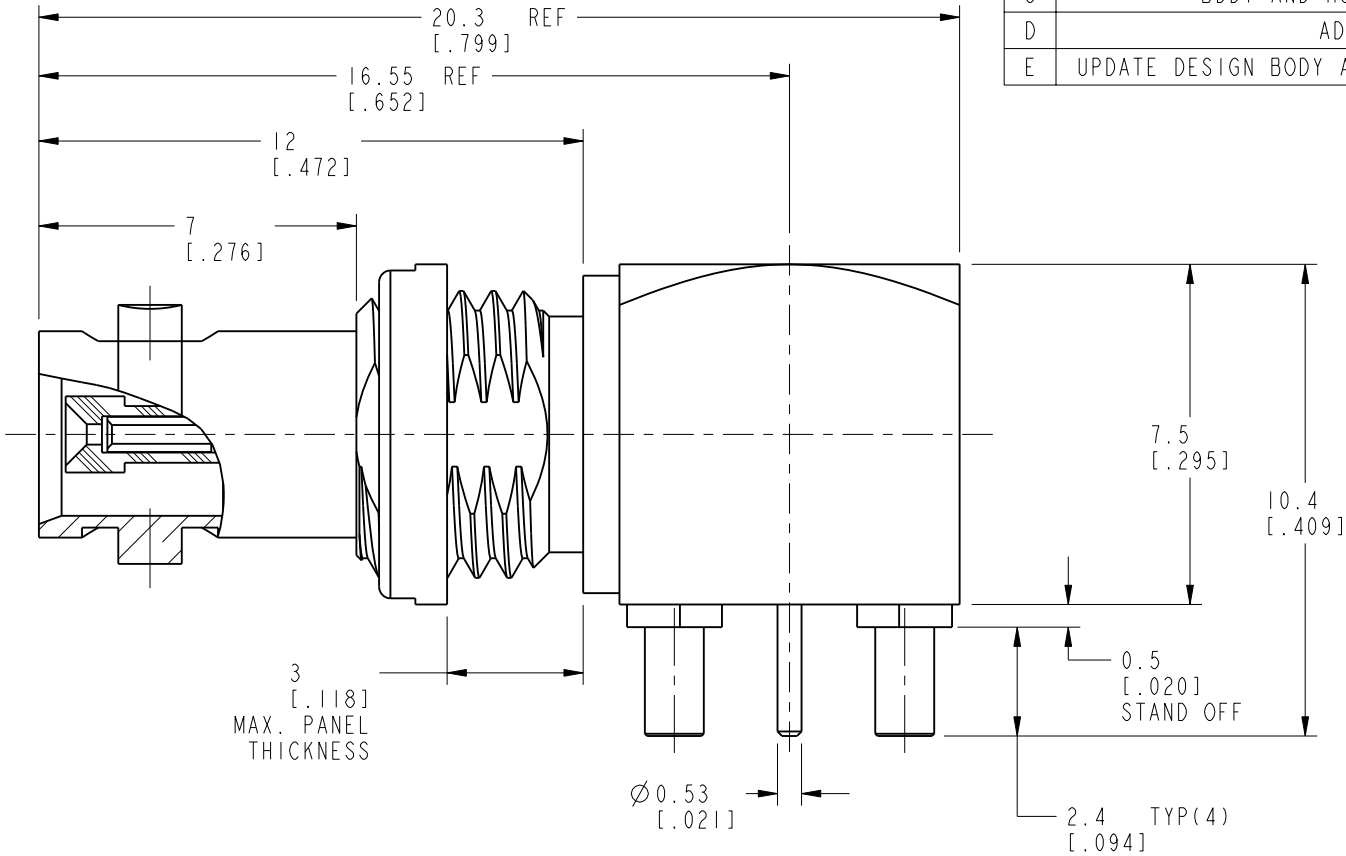


- NOTES:
1. MATERIALS AND FINISHES:
BODY - BRASS, NICKEL PLATING
HOUSING - BRASS, GOLD PLATING
CONTACT - BeCu, GOLD PLATING
INSULATORS - PTFE, NATURAL
2. ELECTRICAL:
A. IMPEDANCE: 75 OHMS
B. FREQUENCY RANGE: DC - 4.5 GHz
C. RETURN LOSS : -25 dB MIN AT 3 GHz
D. DIELECTRIC WITHSTANDING VOLTAGE: 1000 VRMS, MIN.
E. INSULATION RESISTANCE: 10,000 MEGOHMS MIN
3. MECHANICAL:
A. DURABILITY: 500 CYCLES MIN.
4. ENVIRONMENTAL:
A. THERMAL SHOCK PER MIL-STD-202 METHOD 107
TEST CONDITION B (EXCEPT HIGH TEMP @200° C)
B. VIBRATION: MIL-STD-202 METHOD 204 TEST CONDITION B
C. SHOCK: MIL-STD-202 METHOD 213 TEST CONDITION B
D. CORROSION: MIL-STD-202 METHOD 101
TEST CONDITION B 5% SALT SOLUTION
5. PACKAGING:
A. QUANTITY: SINGLE PACK
B. MARKING: BAG TO BE MARKED
"AMPHENOL RF, 34-1030, AND DATE CODE"

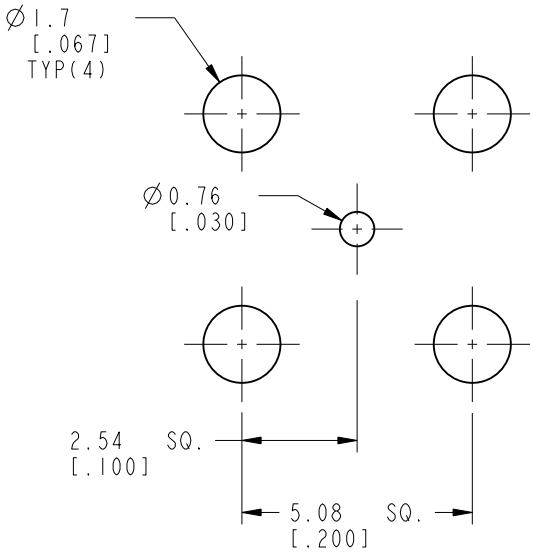
THIRD ANGLE PROJ.

REVISIONS

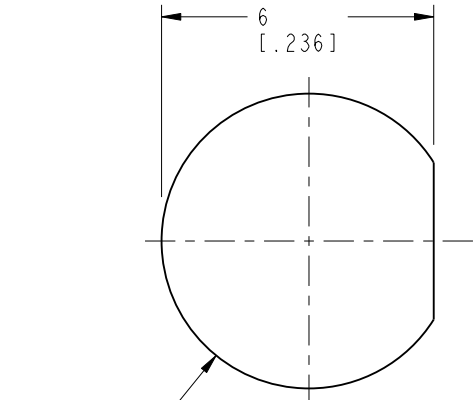
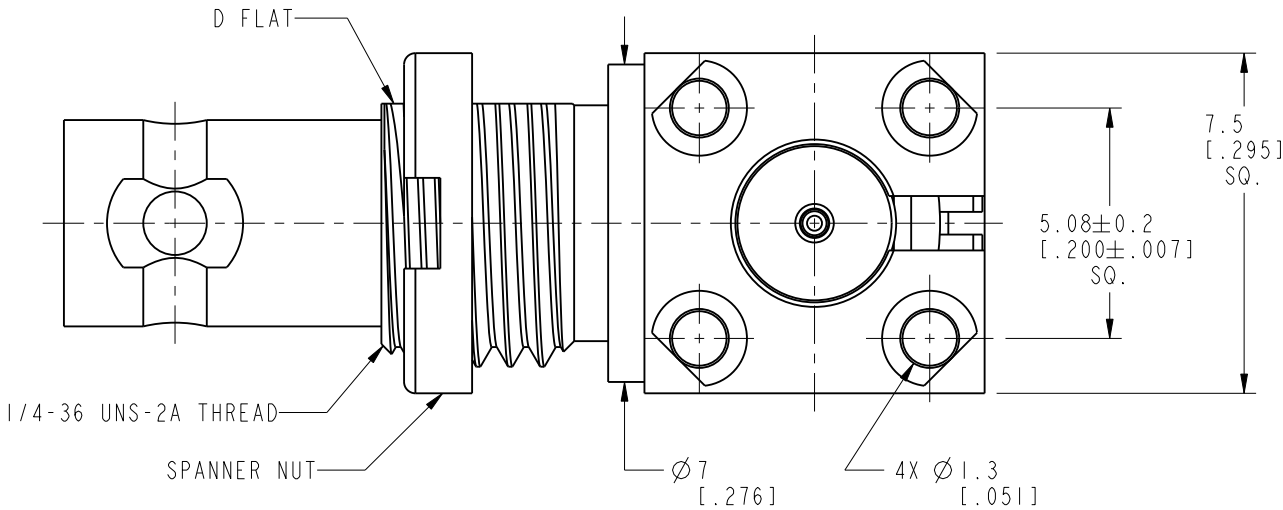
REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASED TO MFG.	13-Oct-10	48270	PNE
B	REMOVED FORMING	09-Dec-10	48368	SH
C	BDDY AND HOUSING WERE CHANGED	10-May-11	--	SH
D	ADD FORMOVER	9/20/11	48780	JTS
E	UPDATE DESIGN BODY AND HOUSING, CAP WAS CHANGED	24-Oct-12	49222	DH



SCALE 4.000



**RECOMMENDED
PCB LAYOUT**



SCALE 6.000
**RECOMMENDED
MOUNTING HOLE**

CUSTOMER OUTLINE DRAWING

ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE:
<0.5mm ± 0.05mm 0.5 - 6mm ±0.1mm 6 - 30mm ±0.2mm 30 - 120mm ± 0.3mm ANGLES ±1°

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MATERIAL SEE NOTES	DRAWN T.DENG	DATE 24-Oct-12	TITLE HD BNC RA BHD JACK PCB MOUNT		Amphenol RF Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com
	ENGINEER NISCHIT MV	DATE 09-Apr-10			
	REFERENCE EAR # 4028	DATE 24-Oct-12	SCALE: 6.0:1.0 SHEET 2 OF 6		DRAWING NO.34-1030
	CONFIGURATION LEVEL:	CAD FILE	DWG SIZE B	REV E	ITEM NO.34-1030 PART NO.34-1030

CONFIGURATION-O

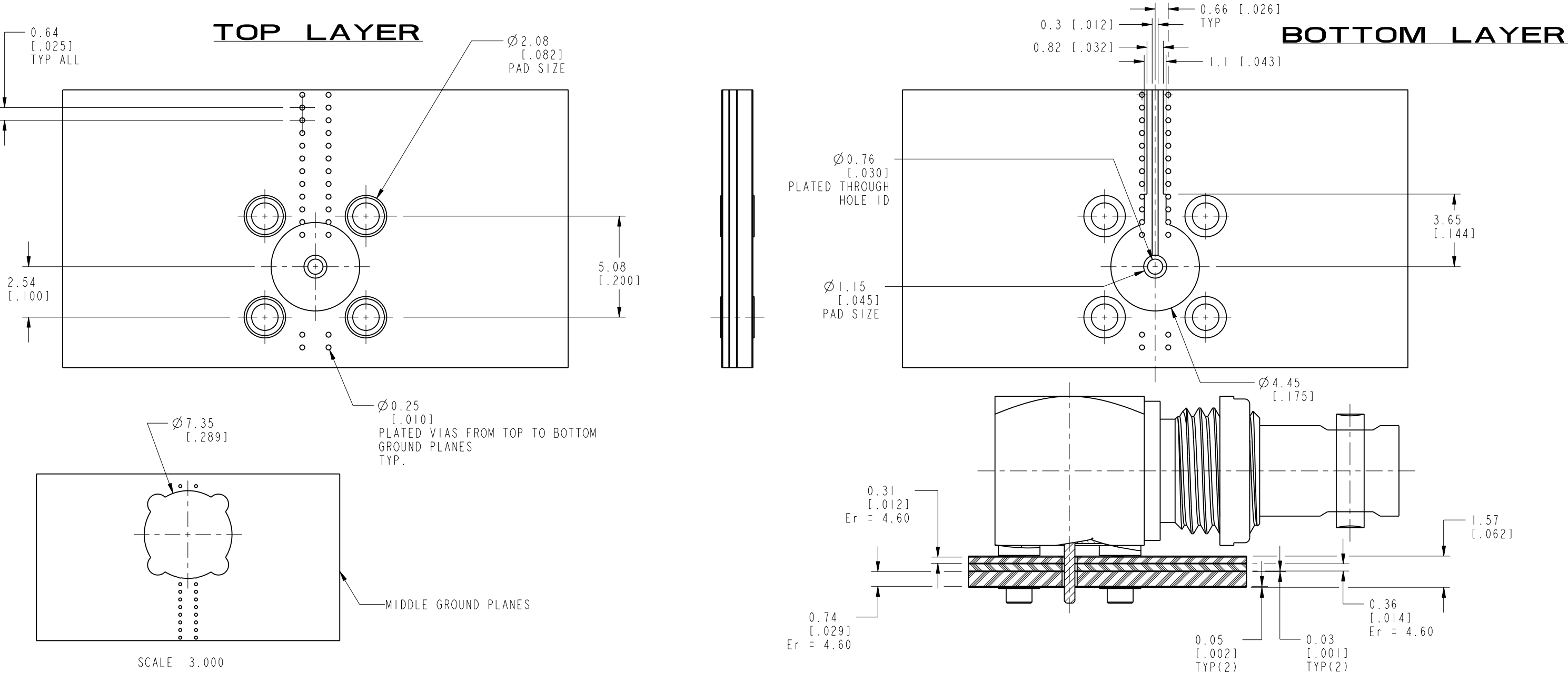
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RECOMMENDED PCB LAUNCH FOR OPTIMAL RF PERFORMANCE

VARIATIONS IN BOARD SUBSTRATE AND TRACE MAY REQUIRE DIFFERENT GEOMETRY



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	ENGINEER NISCHIT MV	DATE 29-Jun-10		
REFERENCE EAR # 4028	APPROVED D.HU	DATE 24-Oct-12	SCALE: 2.0:1.0 SHEET 3 OF 6	DRAWING NO.34-1030
	CONFIGURATION LEVEL:	CAD FILE		ITEM NO.34-1030
FINISH			DWG SIZE B	REV E
				PART NO.34-1030

CONFIGURATION-1

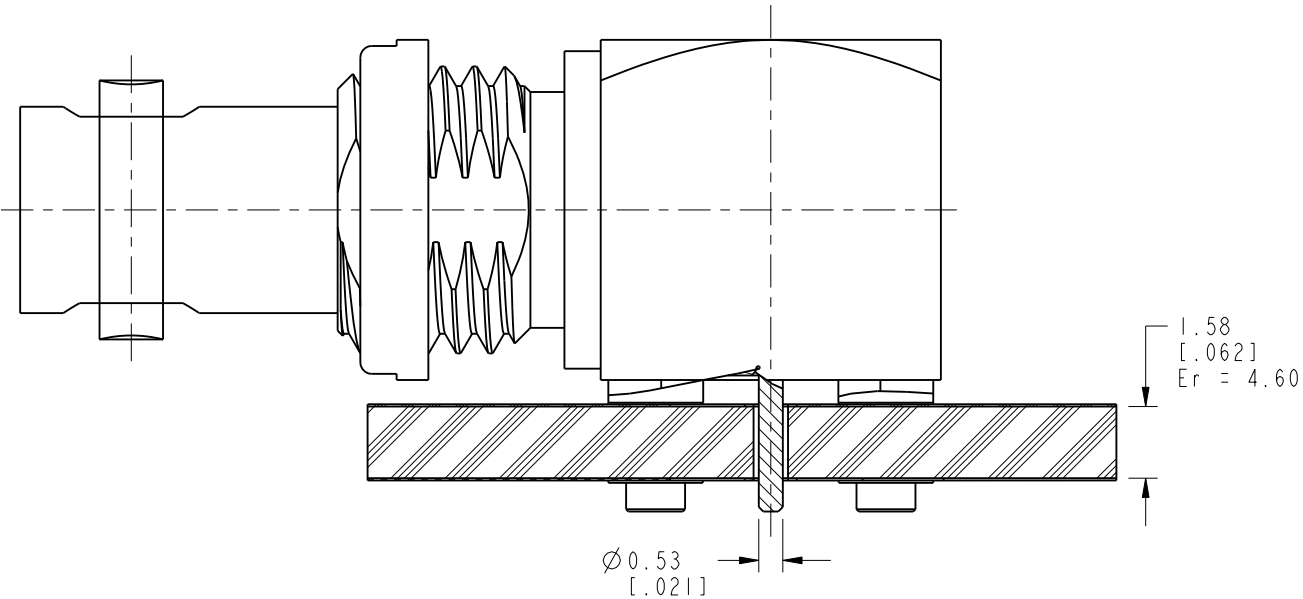
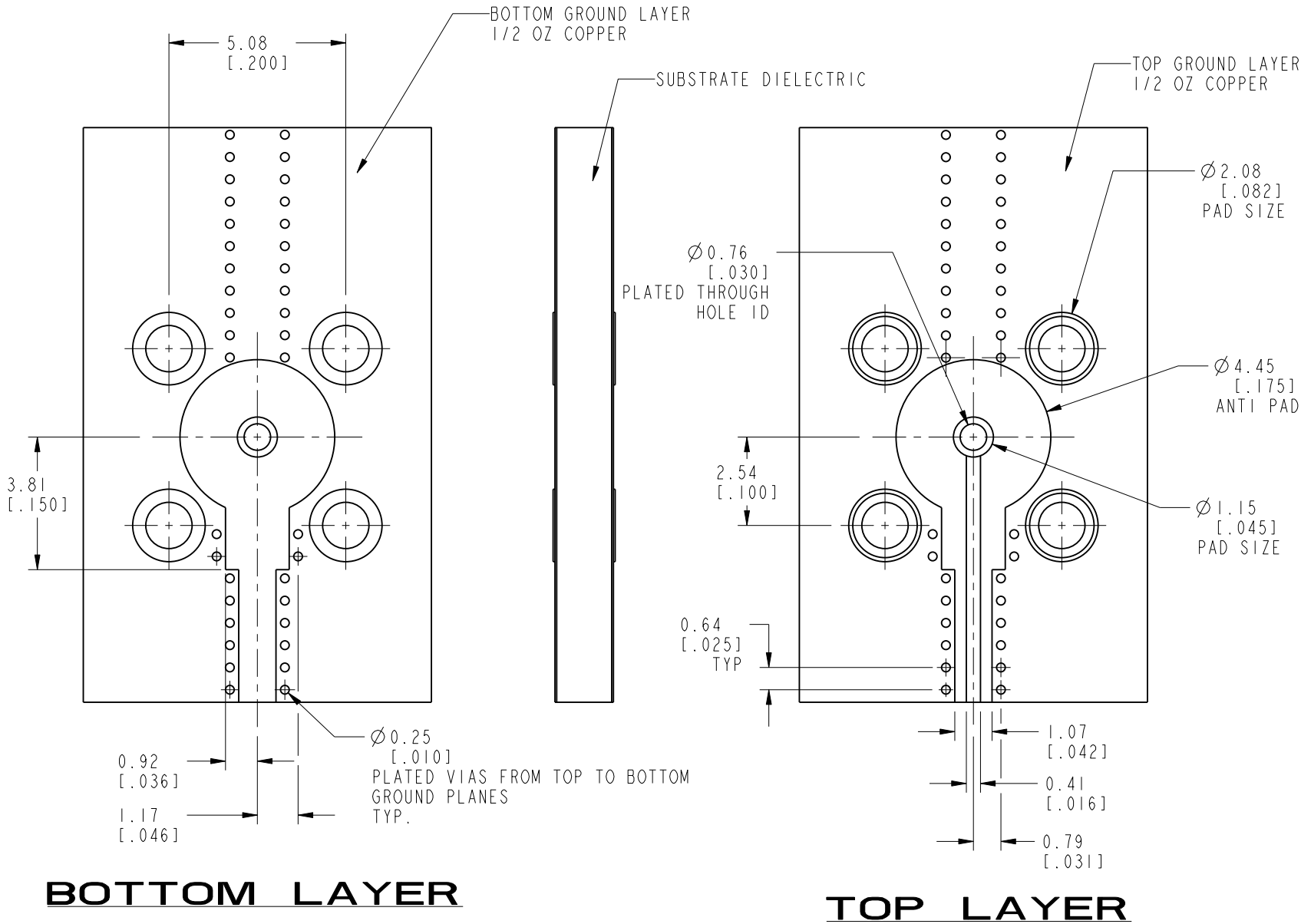
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	REFERENCE EAR # 4028	DATE 24-Oct-12	SCALE: 3.0:1.0 SHEET 4 OF 6		DRAWING NO.34-1030	
	CONFIGURATION LEVEL:	CAD FILE	DWG SIZE B		REV E	ITEM NO.34-1030
FINISH					PART NO.34-1030	

CONFIGURATION-2

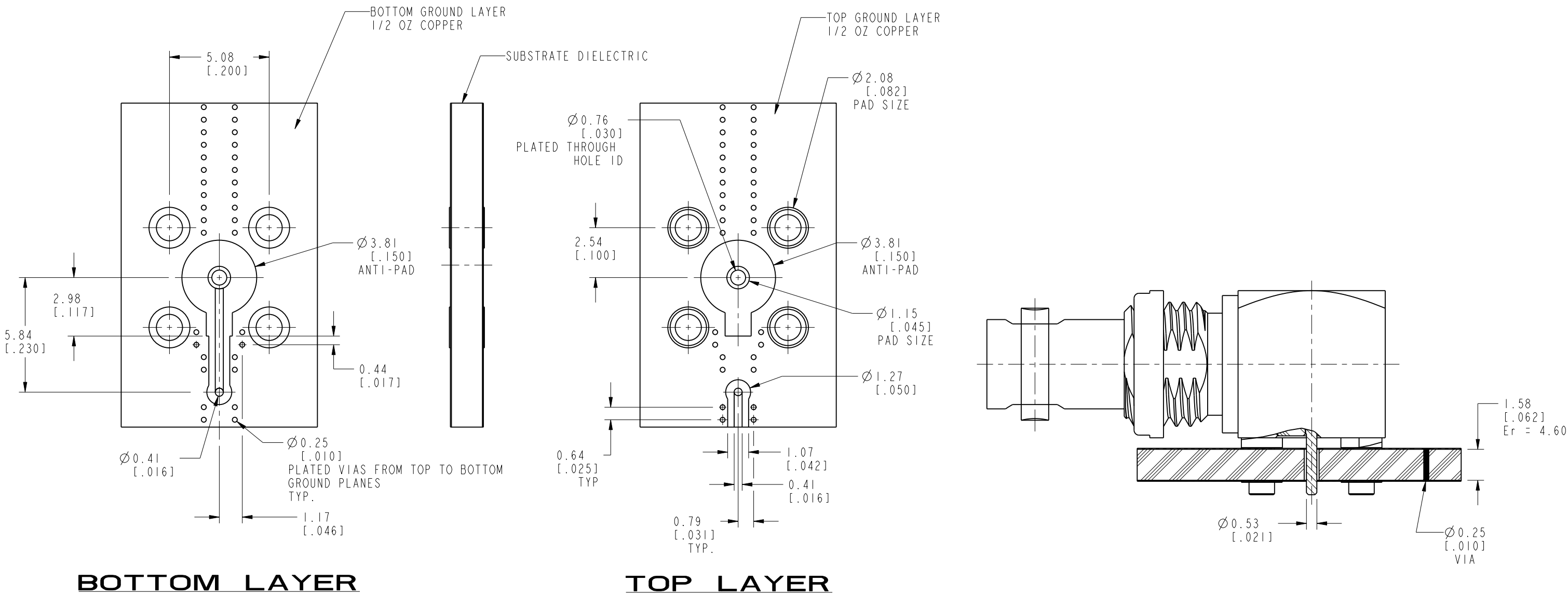
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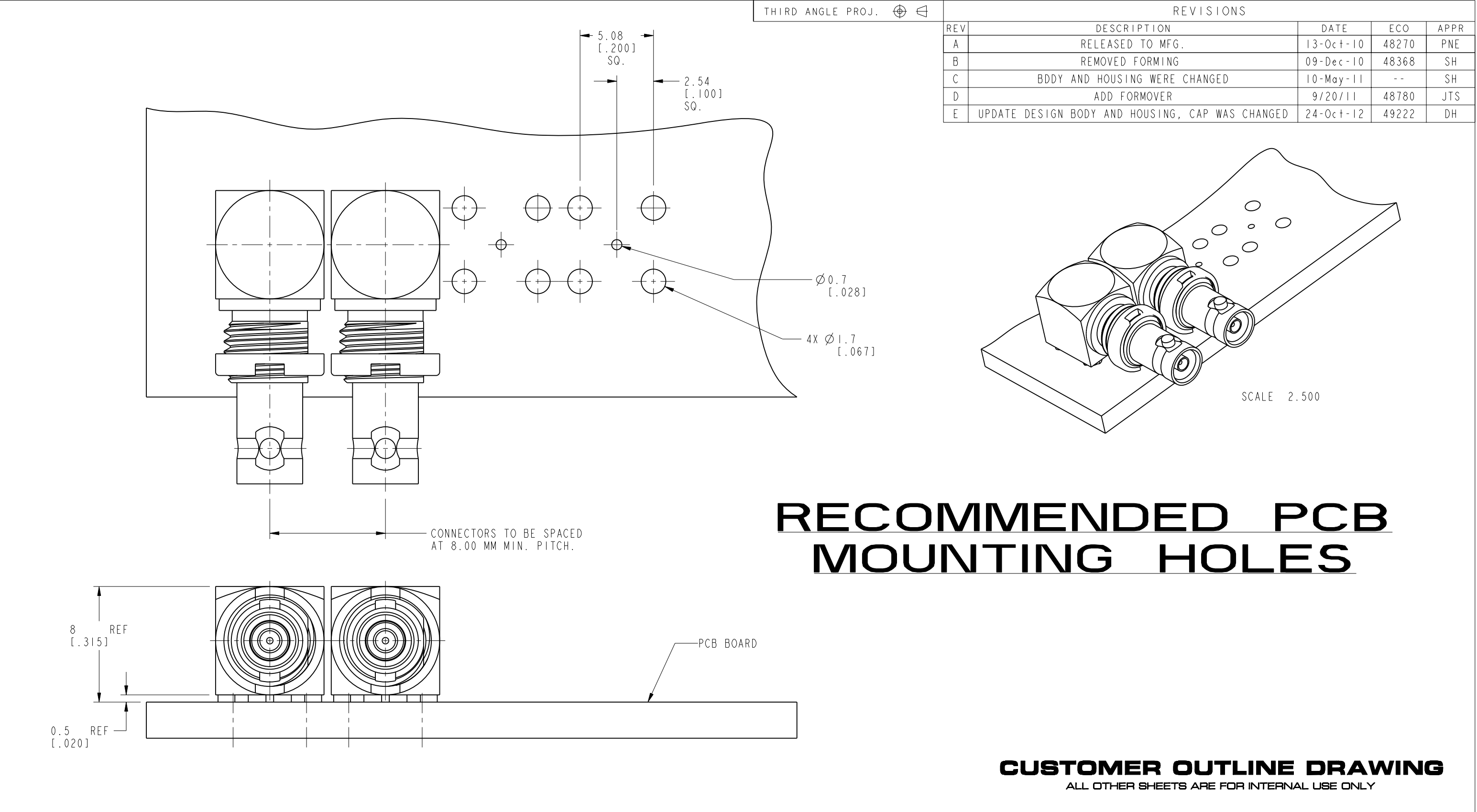
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	CONFIGURATION LEVEL:	APPROVED D.HU	DATE 24-Oct-12	SCALE: 0.8:1.0 SHEET 5 OF 6		DRAWING NO.34-1030	
	FINISH	CAD FILE		DWG SIZE B	REV E	ITEM NO.34-1030 PART NO.34-1030	



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	CONFIGURATION LEVEL:	APPROVED D.HU	DATE 24-Oct-12	SCALE: 7.8:1.0 SHEET 6 OF 6		DRAWING NO.34-1030	
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